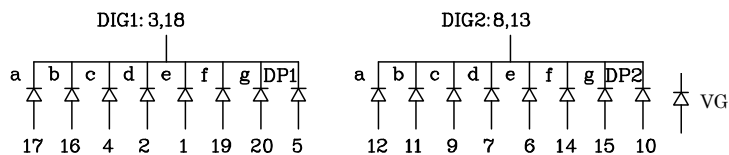


Features

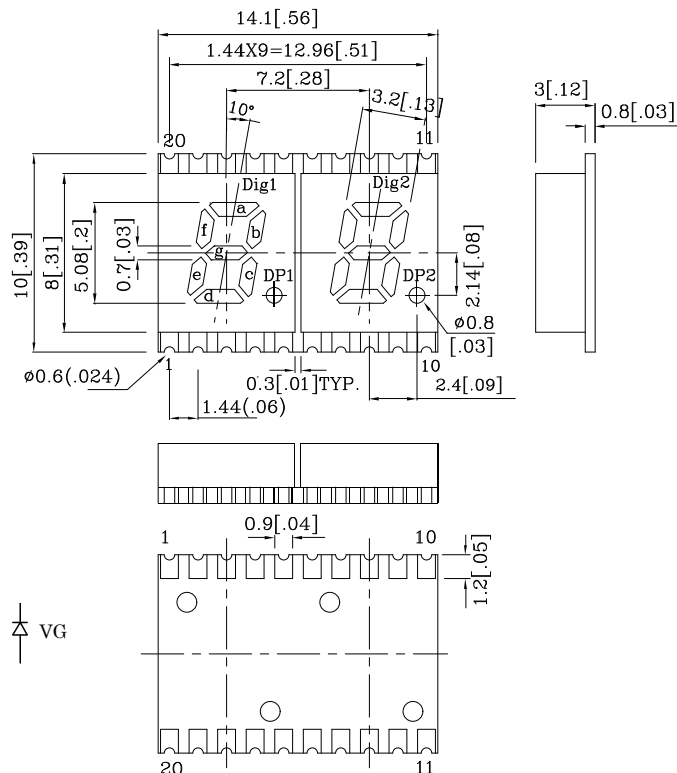
- 0.2 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- GRAY FACE, WHITE SEGMENT.
- PACKAGE : 300PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.



Notes:

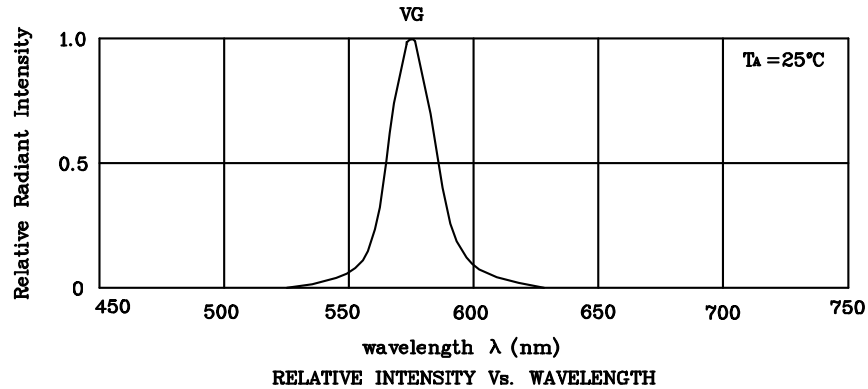
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
- 3.The gap between the reflector and PCB shall not exceed 0.25mm.
- 4.Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		VG (InGaAlP)	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	150	mA
Power Dissipation	PT	75	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

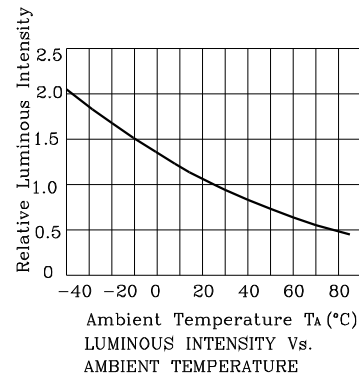
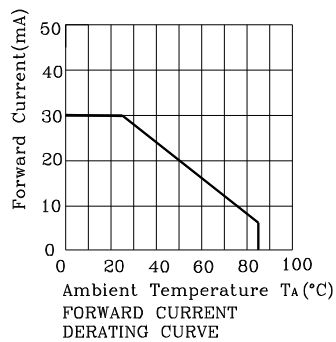
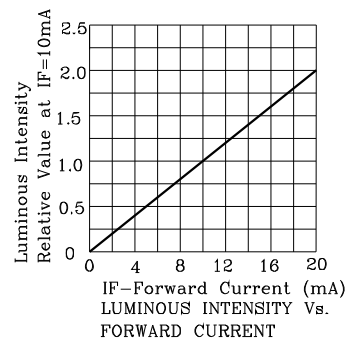
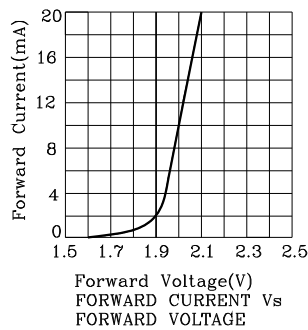


Operating Characteristics (TA=25°C)		VG (InGaAlP)	Unit
Forward Voltage (Typ.) (IF=10mA)	VF	2.0	V
Forward Voltage (Max.) (IF=10mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=10mA)	λ P	574	nm
Wavelength of Dominant Emission (Typ.) (IF=10mA)	λ D	570	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=10mA)	Δλ	20	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd	Wavelength nm λ P	Description
			min.	typ.	
ZFVG05C2	Green	InGaAlP	4700	25990	574 Common Cathode.Rt.Hand Decimal
Published Date : FEB 28,2008 Drawing No :SDSA5309 V4 Checked : Shin Chi P.1/4					



❖ VG



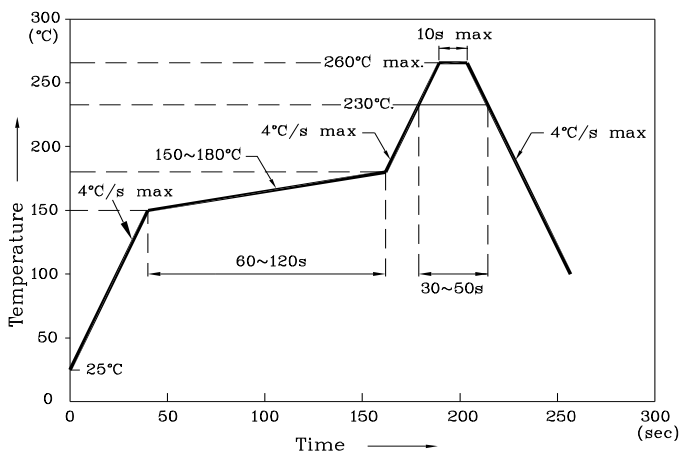
Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: $\pm 1\text{nm}$
2. Luminous Intensity / Luminous Flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

Note: Accuracy may depend on the sorting parameters.

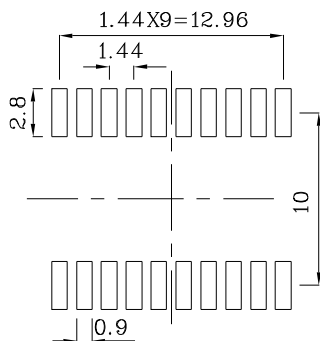
Reflow Soldering Profile For Lead-free SMT Process.



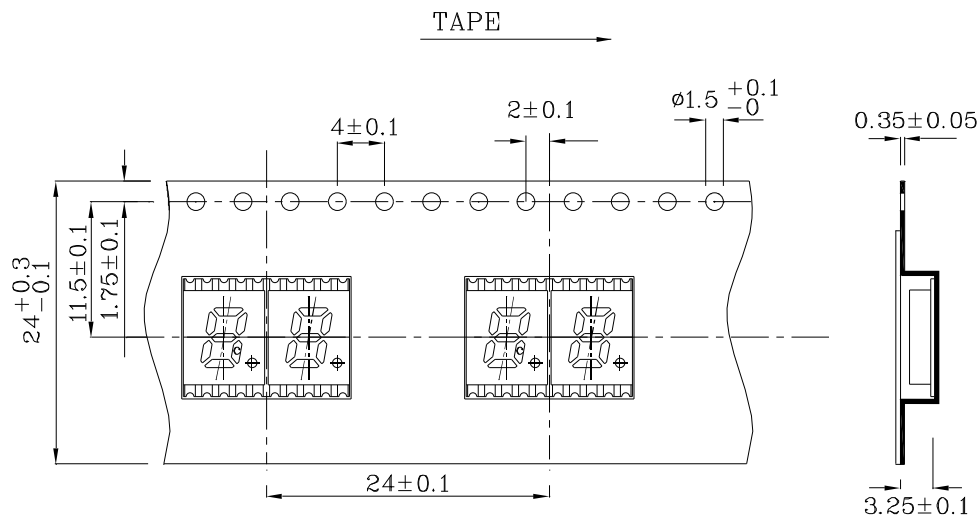
Notes:

- 1.Maximum soldering temperature should not exceed 260°C.
- 2.Recommended reflow temperature: 145°C~260°C.
- 3.Do not put stress to the epoxy resin during high temperatures conditions.

❖ Recommended Soldering Pattern (Units : mm;Tolerance:± 0.15)

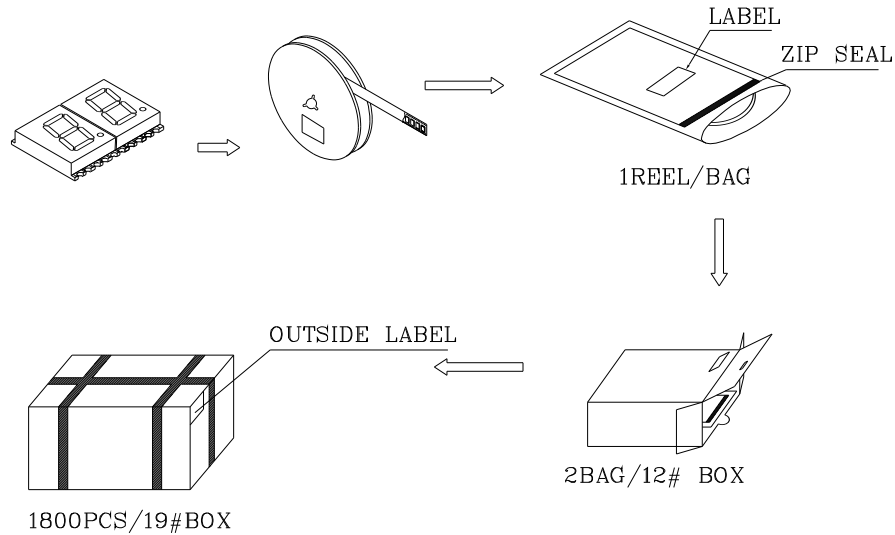


❖ Tape Specification (Units : mm)

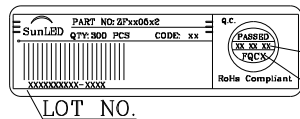


PACKING & LABEL SPECIFICATIONS

ZFVG05C2

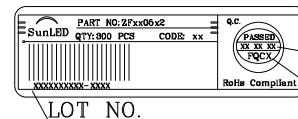


Inside LABEL Paste On The TAPE



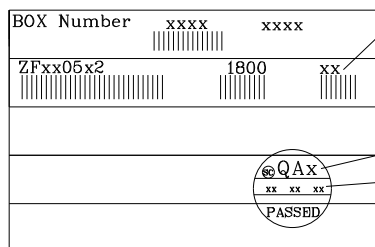
Date
Number OF FQC

Outside LABEL Paste On The BAG



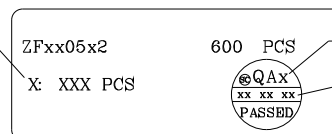
Date
Number OF FQC

Outside LABEL Paste On The 19#Box



Number OF QA
Date

Outside LABEL Paste On The 12#Box



Number OF QA
Date